

| Parameter | Heat | Water | Purge | TMA | Purge | Post |
|--------------------------|------|-------|-------|------|-------|------|
| Step | 1 | 2 | 3 | 4 | 5 | 6 |
| TMA (sccm) | | | | 25 | | |
| Octane (sccm) | | | | 300 | | |
| Water (sccm) | | 0.54 | | | | |
| Ar carrier 2 (sccm) | | 63 | | | | |
| Bubbler (psig) | 35 | 35 | 35 | 35 | 35 | 35 |
| Diluent Ar 2 (sccm) | 200 | 200 | 200 | 200 | 200 | 200 |
| Ar Carrier/Purge 1 (slm) | 0.05 | 0.05 | 0.05 | 0.05 | 2 | |
| Ar Purge 2 (slm) | | | 2 | | | |
| Ar Bottom (slm) | 2 | 2 | 2 | 2 | 2 | |
| Pressure (Torr) | 3 | 3 | 3 | 3 | 3 | |
| Chuck Z1 (°C) | 214 | 214 | 214 | 214 | 214 | 214 |
| Chuck Z2 (°C) | 263 | 263 | 263 | 263 | 263 | 263 |
| Wafer (°C) | 200 | 200 | 200 | 200 | 200 | 200 |
| Time | 180 | 2 | 9 | 2 | 5 | |

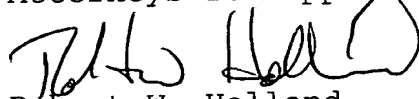
REMARKS

Applicants request the Examiner to enter the above amendment prior to examination of this application. Applicants respectfully submit that the amendment is supported by the specification and add no new matter.

Early and favorable acceptance of this patent application is respectfully requested.

The Commissioner is hereby authorized to charge any fees or credit any overpayment to Deposit Account No. 02-0384 of Baker Botts L.L.P.

Respectfully submitted,
BAKER BOTTS L.L.P.
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Date: 13 June 2001



VERSION WITH MARKINGS TO SHOW CHANGES MADE

THE SPECIFICATION:

Applicants submit that no new matter is included in the table below. The formatting of the table as filed was incorrect. The new table submitted with this Preliminary Amendment contains the correct formatting.

Please replace the paragraph on Page 26, Line 3 with the following paragraph:

--In one embodiment, the following parameters deposit a desirable film:

| Parameter | Heat | Water | Purge | TMA | Purge | Post |
|--------------------------|------|-------|-------|------|-------|------|
| Step | 1 | 2 | 3 | 4 | 5 | 6 |
| TMA (sccm) | | | | 25 | | |
| Octane (sccm) | | | | 300 | | |
| Water (sccm) | | 0.54 | | | | |
| Ar carrier 2 (sccm) | | 63 | | | | |
| Bubbler (psig) | 35 | 35 | 35 | 35 | 35 | 35 |
| Diluent Ar 2 (sccm) | 200 | 200 | 200 | 200 | 200 | 200 |
| Ar Carrier/Purge 1 (slm) | 0.05 | 0.05 | 0.05 | 0.05 | 2 | |
| Ar Purge 2 (slm) | | | 2 | | | |
| Ar Bottom (slm) | 2 | 2 | 2 | 2 | 2 | |
| Pressure (Torr) | 3 | 3 | 3 | 3 | 3 | |
| Chuck Z1 (°C) | 214 | 214 | 214 | 214 | 214 | 214 |
| Chuck Z2 (°C) | 263 | 263 | 263 | 263 | 263 | 263 |
| Wafer (°C) | 200 | 200 | 200 | 200 | 200 | 200 |
| Time | 180 | 2 | 9 | 2 | 5 | |

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